

Ultra small, Single Band LNA-IC for 2.4 GHz Band Applications

FEATURES

• Low voltage operation +3.3 V typ.

• Low current consumption

8.0 mA typ. (High-Gain mode)

30 μA typ. (Low-Gain mode)

High gain
Low noise figure
17.0 dB typ.
(High-Gain mode)
(High-Gain mode)

• Low distortion +4.0 dBm typ. (High-Gain mode)

• 5 pin Wafer level chip size package (WLCSP)

DESCRIPTION

AN26024A is a single band LNA (Low Noise Amplifier)-IC for 2.4 GHz Band applications.

Realizing high performance by using 0.18 μm SiGeC Bi-CMOS process (f_T = 90 GHz, f_{max} = 140 GHz).

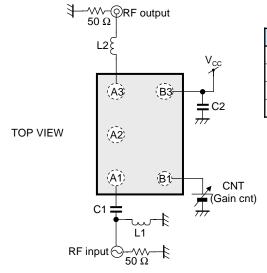
High/Low Gain-mode is changeable, controlled by integrated CMOS logic circuit.

Achieving miniaturization by using small size Wafer Level Chip Size Package (WLCSP).

APPLICATIONS

●WLAN/WiMAX

SIMPLIFIED APPLICATION



Components	Size	Size Value Part Number			
L1	0603	5.1 nH	LQP03TN5N1H04	Murata	
L2	0603	4.7 nH	LQP03TN4N7H04	Murata	
C1	0603	1 000 pF	GRM033B11C102KD01	Murata	
C2	0603	100 000 pF	GRM33B30J104KE18	Murata	

Notes) This application circuit is an example. The operation of mass production set is not guaranteed. You should perform enough evaluation and verification on the design of mass production set. You are fully responsible for the incorporation of the above application circuit and information in the design of your equipment.



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating	Unit	Note
Supply voltage	V _{CC}	3.7	V	*1
Supply current	I _{cc}	18	mA	_
Operating ambient temperature	T _{opr}	-40 to +85	°C	*2
Operating junction temperature	T _j	-40 to +125	°C	*2
Storage temperature	T _{stg}	-55 to +125	°C	*2
	IN (Pin No.A1)	_	V	*3
Input Voltage Range	CNT (Pin No.B1)	-0.3 to V _{CC}	V	_
	OUT (Pin No.A3)	-0.3 to V _{CC}	V	_
ESD	HBM (Human Body Model)	2	kV	_

Notes). This product may sustain permanent damage if subjected to conditions higher than the above stated absolute maximum rating.

This rating is the maximum rating and device operating at this range is not guaranteeable as it is higher than our stated recommended operating range.

When subjected under the absolute maximum rating for a long time, the reliability of the product may be affected.

POWER DISSIPATION RATING

PACKAGE	θ _{JA} PD (Ta=25 °C) PD		PD (Ta=85 °C)
WLCSP	1391°C/W	0.072 W	0.029 W

Note). For the actual usage, please refer to the PD-Ta characteristics diagram in the package specification, supply voltage, load and ambient temperature conditions to ensure that there is enough margin follow the power and the thermal design does not exceed the allowable value.



CAUTION

Although this has limited built-in ESD protection circuit, but permanent damage may occur on it. Therefore, proper ESD precautions are recommended to avoid electrostatic damage to the MOS gates

RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note	
Supply voltage range	V _{CC}	3.0	3.3	3.6	V	*1	

Note) *1: The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

^{*1:}The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

^{*2:}Except for the operating ambient temperature, operating junction temperature and storage temperature, all ratings are for Ta = 25°C.

^{*3:}RF signal input pin. Do not apply DC. Do not apply more than 0 dBm to RF input.



ELECRTRICAL CHARACTERISTICS

Note). $T_a = 25^{\circ}C\pm 2^{\circ}C$, $V_{CC} = 3.3 \text{ V}$

Parameter	Symbol Condition			11:::4	Note			
Farailleter	Symbol	Condition	Min	Тур Мах		Offic	Note	
DC electrical characteristics	DC electrical characteristics							
Supply current HG	I _{cc} H	V _{CC} current at High-Gain mode, No input signal	_	8	11	mA	_	
Supply current LG	I _{cc} L	V _{CC} current at Low-Gain mode, No input signal	_	30	90	μΑ	_	
Input voltage (High-Gain mode)	VIH	_	1.48	_	3.6	V	_	
Input voltage (Low-Gain mode)	VIL	_	0	_	0.6	V	_	
SW current (High)	IIH	Current at CNT pin VIH = V _{CC}	_	30	45	μА	_	

ELECRTRICAL CHARACTERISTICS (continued)

Note). $T_a = 25^{\circ}C\pm 2^{\circ}C$,

 $V_{CC} = 3.3 V,$

fRX = 2.442 GHz, PRX = -30 dBm, CW unless otherwise specified.

Dovemeter	Cumbal	Condition		Limits		Unit	Note
Parameter	Symbol	Condition	Min	Тур	Max	Unit	Note
AC electrical characteristics							
Power Gain HG	GHS	High-Gain mode	15.5	17.0	18.5	dB	_
Power Gain LG	GLS	Low-Gain mode PRX = -20 dBm	-9	-7	-5	dB	_
IIP3 -10 MHz offset HG	IIP3H1S	High-Gain mode f1 = fRX - 10 MHz f2 = fRX - 20 MHz Input 2 signals (f1, f2)	-1	4	_	dBm	



APPLICATION INFORMATION REFERENCE VALUES FOR DESIGN

Note). $T_a = 25^{\circ}C\pm 2^{\circ}C$,

 $V_{CC} = 3.3 V$,

fRX = 2.4 GHz, 2.442 GHz, 2.484 GHz, PRX = -30 dBm, CW unless otherwise specified.

Parameter.	0	O a malistica m	Refe	rence v	11!1	Nete	
Parameter	Symbol	Condition	Min	Тур	Max	Unit	Note
AC electrical characteristics							
Power Gain HG	GH	High-Gain mode	15.5	17	18.5	dB	*1
Power Gain LG	GL	Low-Gain mode PRX = -20 dBm	-9	-7	- 5	dB	*1
Noise Figure HG	NFH	High-Gain mode	_	1.0	1.4	dB	*1,*2
Noise Figure LG	NFL	Low-Gain mode	_	7	9.5	dB	*1,*2
IIP3 –10 MHz offset HG	IIP3H1	High-Gain mode f1 = fRX - 10 MHz f2 = fRX - 20 MHz Input 2 signals (f1, f2)	-1	4	_	dBm	*1
IIP3 +10 MHz offset HG	IIP3H2	High-Gain mode f1 = fRX + 10 MHz f2 = fRX + 20 MHz Input 2 signals (f1, f2)	-1	4	_	dBm	*1
Input P1dB HG	IP1dBH	High-Gain mode	-20	-13	_	dBm	*1
IIP3 +100 kHz offset LG	IIP3L	Low-Gain mode f1 = fRX f2 = fRX + 100 kHz Input 2 signals (f1, f2)	10	24	_	dBm	*1
Input P1dB LG	IP1dBL	Low-Gain mode	0	8	_	dBm	*1
Reverse Isolation HG	ISOH	High-Gain mode	30	36	_	dB	*1
Reverse Isolation LG	ISOL	Low-Gain mode	5	7	_	dB	*1
Input Return Loss HG	S11H	High-Gain mode	8.5	14	_	dB	*1
Input Return Loss LG	S11L	Low-Gain mode	4	5	_	dB	*1
Output Return Loss HG	S22H	High-Gain mode	8.5	12	_	dB	*1
Output Return Loss LG	S22L	Low-Gain mode	6.5	10		dB	*1

Note) *1 : Checked by design, not production tested.

*2 : RF input Connector & substrate loss (0.09 dB) included.



APPLICATION INFORMATION (continued)

REFERENCE VALUES FOR DESIGN (continued)

Note). $T_a = -40^{\circ}\text{C}$ to 85°C , $V_{\text{CC}} = 3.0$ to 3.6 V ,

	Parameter	Symbol Condition		Reference values			Unit	Noto
	Parameter			Min	Тур	Max	Unit	Note
D	C electrical characteristics							
	Supply current HG	I _{cc} HT	V _{CC} current at High-Gain mode No input signal	_	8	12.7	mA	*1
	Supply current LG	I _{cc} LT	V _{CC} current at Low-Gain mode No input signal	_	30	100	μА	*1
	SW current (High)	IIHT	Current at CNT pin VIH = V _{CC}		30	51	μА	*1

Note) *1 : Checked by design, not production tested.



APPLICATION INFORMATION (continued) REFERENCE VALUES FOR DESIGN (continued)

Note). $T_a = -40^{\circ}C$ to $85^{\circ}C$,

 $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$,

fRX = 2.4 GHz, 2.442 GHz, 2.484 GHz, PRX = -30 dBm, CW unless otherwise specified

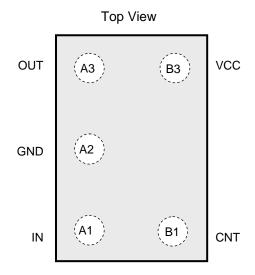
Davamatan	Cumb al	Condition	Refer	ence v	I I mid	Nata	
Parameter	Symbol Condition		Min	Тур	Max	Unit	Note
AC electrical characteristics							
Power Gain HG	GHTa	High-Gain mode	14.3	17	19.8	dB	*1
Power Gain LG	GLTa	Low-Gain mode PRX = -20 dBm	-9.8	-7	-4.5	dB	*1
Noise Figure HG	NFHTa	High-Gain mode	_	1.0	2.0	dB	*1,*2
Noise Figure LG	NFLTa	Low-Gain mode	_	7	10.2	dB	*1,*2
IIP3 -10 MHz offset HG	IIP3H1Ta	High-Gain mode f1 = fRX - 10 MHz f2 = fRX - 20 MHz Input 2 signals (f1, f2)	-2.3	4	_	dBm	*1
IIP3 +10 MHz offset HG	IIP3H2Ta	High-Gain mode f1 = fRX + 10 MHz f2 = fRX + 20 MHz Input 2 signals (f1, f2)	-2.3	4	_	dBm	*1
Input P1dB HG	P1dBHTa	High-Gain mode	-23.6	-13	_	dBm	*1

Note) *1 : Checked by design, not production tested.

^{*2 :} RF input Connector & substrate loss (0.09 dB) included.



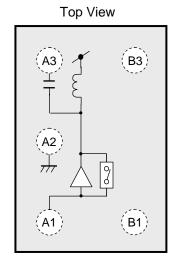
PIN CONFIGURATION



PIN FUNCTIONS

Pin No.	Pin name	Туре	Description
A1	IN	Input	RF Input
A2	GND	Ground	GND
А3	OUT	Output	RF Output
B1	CNT	Input	High-Gain/Low-Gain switch L: Low-Gain Mode H: High-Gain Mode
В3	VCC	Power Supply	V _{cc}

FUNCTIONAL BLOCK DIAGRAM

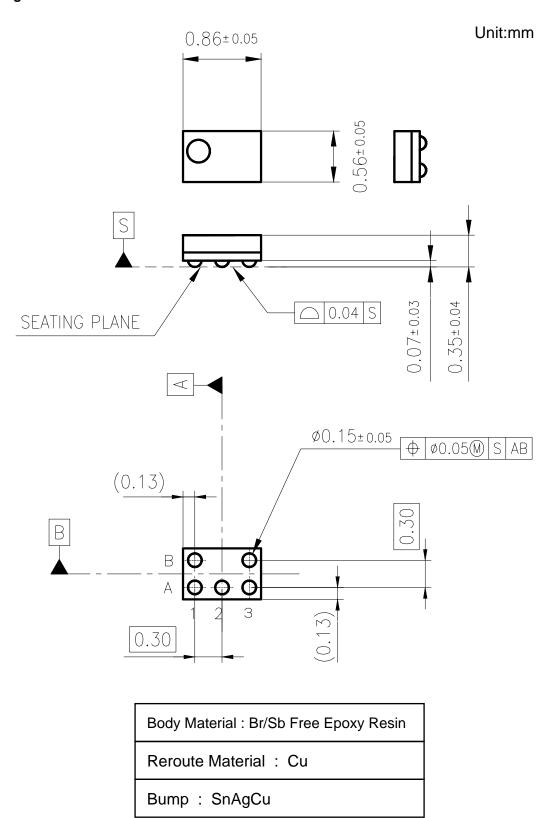


Notes) • This block diagram is for explaining functions. Part of the block diagram may be omitted, or it may be simplified.



PACKAGE INFORMATION (Reference Data)

Package Code: ALGA005-W-0609ANA





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- (8) Others: Applications of which reliability equivalent to (1) to (7) is required

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 - Even when the products are used within the guaranteed values, take into the consideration of incidence of break down and failure mode, possible to occur to semiconductor products. Measures on the systems such as redundant design, arresting the spread of fire or preventing glitch are recommended in order to prevent physical injury, fire, social damages, for example, by using the products.
- 2. Comply with the instructions for use in order to prevent breakdown and characteristics change due to external factors (ESD, EOS, thermal stress and mechanical stress) at the time of handling, mounting or at customer's process. When using products for which damp-proof packing is required, satisfy the conditions, such as shelf life and the elapsed time since first opening the packages.
- 3. Pay attention to the direction of LSI. When mounting it in the wrong direction onto the PCB (printed-circuit-board), it might smoke or ignite.
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- 5. Perform a visual inspection on the PCB before applying power, otherwise damage might happen due to problems such as a solder-bridge between the pins of the semiconductor device. Also, perform a full technical verification on the assembly quality, because the same damage possibly can happen due to conductive substances, such as solder ball, that adhere to the LSI during transportation.
- 6. Take notice in the use of this product that it might break or occasionally smoke when an abnormal state occurs such as output pin-VCC short (Power supply fault), output pin-GND short (Ground fault), or output-to-output-pin short (load short) .
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- 7. Due to unshielded structure of this LSI, under exposure of light, function and characteristic of the product cannot be guaranteed. During normal operation or even under testing condition, please ensure that LSI is not exposed to light.
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